Inkjet printed mesoscopic perovskite solar cells with custom design capability†

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Customizable solar cells are required for aesthetic indoor and outdoor photovoltaic deployment as well as for the freedom of design of small and portable power supplies. We demonstrate that drop-on-demand inkjet printing can be used for the fabrication of monolithic mesoscopic carbon-based perovskite solar cells by printing all of the oxide layers in the stack as well as the organo-metal halide absorber. Printable inks using environmentally friendly solvents and jetting parameters were developed in order to achieve homogenous and continuous functional layers of the photovoltaic stack. Inkjet printed cells are compared to those obtained from the standard screen-printing route. As a proof of principle, photovoltaic cells with an area of 1.5 cm² and a performance of 9.1% were realized by inkjet printing, which opens up intriguing application possibilities.

Introduction

Economy of scale has led to an amazing deployment of crystalline silicon solar cell technology in the past decades. While this development has established industrial manufacture of square or rectangular module shapes for convenient coverage of large areas, few technologies have addressed the production of customized shapes for photon to electrical energy conversion. Crystalline solar cells with particular shapes improving the aesthetics or even dummies are typical approaches used in building integration. Such approaches, however, are always limited by processing constraints and full freedom of design can only be reached if photovoltaic cells can be fabricated by printing techniques. Digital stencil-less techniques such as drop-on-demand (DOD) inkjet printing are particularly compelling for this purpose. In addition, they offer straightforward industrialization capability.

Inkjet printing has quite widely been used in photovoltaic device fabrication, e.g. for depositing silver lines or antireflective structures on crystalline silicon wafers. Contrary to wafer technologies, thin film photovoltaic technologies allow to inkjet the active materials of the solar cell stack. For example, inkjet printed chalcopryte and kesterite absorbers have demonstrated promising device efficiencies. Among the possible solar cell technologies fulfilling the requirements for inkjet printing, organic solar cells have been most widely studied and fully inkjet printed devices have indeed been achieved. However, the rather modest device efficiencies of 3–4% have dampened enthusiasm along this direction. The same is true for dye-sensitized solar cells (DSSCs). In the latter case, inkjet printing allowed to finely dose the appropriate volume of liquid electrolyte into the mesoporous oxide layer. Another study reported on staining the TiO₂ photoelectrode by inkjet printing. It is more challenging to inkjet print nanoparticle inks due to nozzle clogging and it is all the more remarkable that deposition of the mesoporous TiO₂ layer has been achieved by DOD technique. Despite these substantial achievements, inkjet printing of DSSCs has not received much attention, probably, because device efficiency stayed below 5–6%. Renewed interest in inkjet printing has been spurred by the soaring performance of the young lead-halide perovskite solar cell (PSC) technology. Advantageously, PSC stacks can be printed at low temperature, much the same way as for organic solar cells. One critical component is the absorber layer itself, which ideally consists of a continuous, large grained crystalline layer in planar architectures. Few works reported on inkjet-printed CH₃NH₃PbI₃ (MAP) layers directly on planar compact TiO₂ (e-TiO₂) coated conductive glass substrates and employed a vacuum assisted post-treatment to achieve uniform crystalline films. Other works used a thin mesoporous TiO₂ (m-TiO₂) electron extraction layer, on top of which lead-iodide was first inkjet printed and subsequently converted to the perovskite by using inter-diffusion of methyl-ammonium iodide. Interestingly, it was noted that...
The mesoscopic layer provided a perfect wetting layer for lead-iodide, pinning the liquid at the boundary of the oxide layer. Alternatively, it was shown that a blend of nanocarbon and methyl-ammonium iodide can be inkjet printed onto the lead-iodide film. By means of a diffusion process, the latter transforms into the active perovskite absorber with overlaying carbon electrode. Another work has achieved both the sequential deposition of thin m-TiO$_2$ and the perovskite layer to achieve an average efficiency of 12.2% on small laboratory cell areas. Among the various perovskite device architectures, the so-called triple layer mesoporous metal-oxide monolithic architecture using a porous carbon back contact (MPSC) presents considerable advantages for inkjet printing the active perovskite absorber (Fig. 1). In those types of cells, a porous scaffold consisting of a mesoporous TiO$_2$ layer (m-TiO$_2$), a mesoporous ZrO$_2$ (m-ZrO$_2$) layer followed by a porous carbon layer presents an excellent texture for infiltrating the lead-halide salt ink droplets. Furthermore, the robust and rather thick cell architecture is defect tolerant and promises straightforward large area scale-up. The extremely thick hydrophobic carbon layer prevents water ingress to the active layer and therefore warrants long lifetime and prevents washing out the lead salt in the case of fragmentation. It has been demonstrated that the active perovskite absorber can be infiltrated by inkjet printing, leading to stable MPSC cells with an average efficiency of 7%. If however the customizability of digital drop-on-demand DOD technology shall be exploited, all stacks of the MPSC must be printed by inkjet. As reviewed by Peng et al. and Karunakaran et al., most of the efforts so far have focused on inkjet printing the absorber layer or one of the device electrodes. To the best of our knowledge, there has been no work reporting on the fabrication of perovskite solar cells by inkjet printing all active layers.

In this work, we demonstrate a fully solution processed MPSC with four layers out of five inkjet printed in ambient conditions. In particular, all the metal oxide layers, i.e. c-TiO$_2$, m-TiO$_2$ and m-ZrO$_2$ as well as the perovskite precursor ink were deposited by inkjet. The oxide layers and the carbon electrode were first sintered at elevated temperature and then infiltrated with the standard MAPI by inkjet at room temperature. Cells were fully characterized and compared to standard screen-printed devices. In addition, we highlight the advantages of precise, waste-free infiltration using inkjet and provide guide values for the printing speed that can be achieved by this technology. We also demonstrate highly stable and environmentally friendly inks for each of the MPSC layers using non-halogenated solvents.

**Experimental Characterization**

Viscosity and density of the inks were measured on a falling ball viscometer from Anton Paar (LOVIS 2000 ME). Surface tension and wetting of the inks were characterized using a drop shape analyzer from Krüss (DSA30). Contact angle measurements for determining the wetting envelope were carried out on the individual solar cell stack layers after firing them at 500°C for 1 h. The thickness of the layers was determined with a profilometer (XP-1 Surface Profilometer, Ambios Technology). The film surface was characterized by atomic force microscopy (ICON3 from Bruker) in tapping mode. The crystallization behavior of the nanoparticles as well as the perovskite formation in the mesoporous structure were analyzed by XRD (Pan Analytics, X’Pert PRO). SEM images were taken with a FEI NanoSEM 230.

Solar cells were fabricated on a 10 cm x 10 cm fluorine doped tin oxide (FTO) coated glass and were cut into 18 individual cells with 1.5 cm$^2$ active area each (Fig. S1, ESI†). Silver contacts were applied on both anode and cathode sides for current collection. The solar cells were fitted with an opaque black adhesive vinyl mask bearing a 0.64 cm$^2$ aperture (Solaronix SA) and measured in a Solar-Sim 150 solar simulator.
(Solaronix SA) calibrated to 1000 W m$^{-2}$. The voltage was scanned between −0.3 and 1 V, in 5 mV increments every 1.2 s. Typically, more than 5 cells were measured for each development stage of the inkjet printed stack layers. Thereof, the mean solar cell figures and standard deviations were extracted, as well as the champion cell characteristics.

Materials

For the development of a TiO$_2$ ink allowing to obtain a homogenous and pinhole free compact layer, 75 wt% titanium diisopropoxide bis(acetylacetone) (TAA) in isopropanol (Sigma Aldrich) was used. Titania paste Ti-Nanoxide T165/SP (Solaronix SA, Switzerland) and zirconia paste Zr-Nanoxide ZT/SP (Solaronix SA, Switzerland) were adapted for inkjet printing. The utilized carbon paste (Elcocarb B/SP) is a mixture of 25 wt% of carbon nanoparticles and graphite flakes and was used for screen-printing the top electrode. For the perovskite precursor ink, 1.2 mole of lead iodide, 1.2 mole of methylammonium iodide and 0.06 mole of ammonium valeric acid iodide were dissolved in 1 mL of γ-butyrolactone (GBL).

Device fabrication

Devices were fabricated on FTO coated glass, which was cleaned using pH neutral surfactant, acetone, isopropanol (iPrOH) and deionized water. The glasses were then dried with pressurized air and on a hot plate for 10 min at 110 °C. For the fabrication of reference MPSC devices, previously optimized thicknesses were used as follows: 50 nm c-TiO$_2$, 500 nm m-TiO$_2$, 1000 nm m-ZrO$_2$, 10–12 μm porous carbon as reported. For reference devices, the c-TiO$_2$ ink was deposited by spray pyrolysis, while all other layers were deposited by screen-printing using a DEK148 semi-automatic screen printer. Ti-Nanoxide T165/SP (Solaronix SA), Zr-Nanoxide ZT/SP (Solaronix SA) and Elcocarb B/SP (Solaronix SA) were printed using a 165–30, 90–48 and 43–80 mesh stencil, respectively. The screen printing inks of m-TiO$_2$ and m-ZrO$_2$ are composed of metal oxide nanoparticles with a diameter of 20 nm. The carbon ink consists of graphite flakes with typical dimensions of several microns and nano-particle carbon about 30 nm in size. The wet film was allowed to dwell for 10 min before drying at 120 °C for 10 min and then firing at 500 °C to remove all organic binders. Carbon was fired at 400 °C for 1 h.

Inkjet printing was carried out on a PixDro LP50 printer from Meyer Burger. Various print heads were investigated for various layers ranging from lab scale Dimatix DMC11601 and DMC11610 and semi-industrial spectra S-class with 128 nozzle printhead.

Inkjet printing was developed by replacing the sprayed or screen-printed layer one by one by the corresponding inkjet printed layer. The substitution implied the c-TiO$_2$, m-TiO$_2$ as well as the m-ZrO$_2$ layer. Each layer was optimized to reach comparable performance to the screen-printed cells using the standard semi-manual pipetting method for infiltrating the MAPi ink. All oxides, i.e. c-TiO$_2$, m-TiO$_2$ and m-ZrO$_2$ were deposited using a spectra print-head. For the perovskite precursor a Dimatix print head was used. The line per inch (lpi) and dots per inch (dpi) values were optimized for each layer to achieve homogenous layer formation as well as to deposit a controlled liquid volume on to the substrate resulting in the adequate fired layer thickness. Drying and post annealing sequences were optimized individually. The c-TiO$_2$ layer was first dried at 70 °C for 10 min and then heated to 500 °C for 1 h before depositing the next layer. The wet m-TiO$_2$ and m-ZrO$_2$ films were dried at 110 °C, both layers were fired at 500 °C for 1 h after the drying step.

The perovskite precursor was re-dissolved at 70 °C right prior to use. After deposition, the perovskite films were annealed at 50 °C for 10 min on a hot plate in ambient conditions.

Results and discussion

Ink formulation and inkjet deposition

As commonly used in the PSC field, a compact titania blocking layer (c-TiO$_2$) was first deposited on FTO coated glass. The homogeneity of this layer is critical to device performance, since it has to inhibit possible short circuits caused by pinholes in the oxide layer. A compact titania is generally deposited using spin coating, spray pyrolysis, sputtering or atomic layer deposition. Inkjet printing the compact layer is challenging due to hydrolysis of the sol-gel precursor ink in ambient conditions, which can lead to clogging of the nozzles. Such effects have indeed been described for the inkjet deposition of thin photocatalytic TiO$_2$ layers. Furthermore, depositing a thin homogeneous and continuous film on the rough FTO surface, without crack or pinhole formation is delicate. Commercially available slot die coating ink from Solaronix (Ti-Nanoxide BL150/DC) is closest to inkjet ink requirements and thus was tested for inkjet printing. We were able to get a continuous printed wet film, but upon drying the film destabilized and became inhomogeneous. We also observed particle formation at the nozzle plate when jetting was prolonged for several hours. We thus formulated a new ink starting from the TAA stock solution using an appropriate dilution with binary mixtures such as ethylene glycol:isopropanol, tertran:isopropanol, terpineol:isopropanol, ethylene glycol:ethanol, tertran:ethanol, terpineol:ethanol (see ESI†). Advantageously, all binary systems lie within the wetting envelope of the FTO substrate (Fig. 2a) and therefore ensure excellent wet layer formation. The c-TiO$_2$ ink using 1 : 15 vol/vol of TAA into binary solvent yielded a homogeneous and pinhole free layer of 60 nm in thickness after firing at 500 °C for 1 h. The printing was done in a two-pass wet on wet deposition sequence without drying steps between the two deposition steps.

Spin coating, screen-printing and slot die coating of the m-TiO$_2$ layer has been reported in various perovskite solar cell architectures. Inkjet printing of thin mesoporous oxide layers (80–100 nm) in planar perovskite solar cell device architectures has been reported using a Dimatix printhead with multipass printing. Here a jettable m-TiO$_2$ ink was developed by diluting the commercial screen printing paste (Solaronix SA) using a binary solvent mixture (see ESI, Fig. S2). Using the reported recipe and process to reach 500 nm of dried thickness with
Inkjet printing of zirconia nanoparticle inks have not been reported to the best of our knowledge. The challenge is to formulate a stable nanoparticle dispersion, which does not clog the nozzles and has high enough concentration to form a 1000 nm thick layer after firing at 500 °C. We followed a similar binary solvent strategy as used for m-TiO₂ ink development. The spectra printhead was used for obtaining important wet thicknesses required to reach the targeted layer thickness. The screen printing paste from Solaronix was diluted with binary solvent mixtures (see ESI, Fig. S2), which all fall in the stable wetting envelope as shown in Fig. 2a. Series of concentrations and ratios of solvent mixtures were screened. The binary solvent ink gave stable jetting with no satellite formation as well as homogenous film formation (ESI† Fig. S1 and S2). The wet films were dried on a hot plate for 10 min at 110 °C in ambient condition and subsequently fired at 500 °C for 1 h before receiving the carbon layer.

Infiltration of methyl ammonium lead tri-iodide (MAPI)

Inkjet printing of the perovskite precursor solution provides a novel method to infiltrate MPSC. It is a precise and waste free deposition technique as well as clean deposition method. Precise volume control and drop placement promises device-to-device reproducibility as well as performance. The clear advantage of inkjet deposition over pipette infiltration is illustrated in Fig. 2b and c. Semiautomatic pipetting has the disadvantage of considerable liquid thickness variations with a larger liquid volume in the centre of the device. Upon drying, this leads to a deterioration of the upper layers of the carbon electrode. Also it is impossible to achieve a precise edge definition. However, using inkjet deposition, precise volumes of ink can be deposited with high spatial resolution. Inkjet printing of the perovskite precursor has been reported by Hashmi et al. for MPSC with power conversion efficiencies of 8.5% for an active area 0.16 cm². Here the same ink recipes were adopted and further optimized with respect to the filling of the mesoporous structure by varying ink volumes, optimizing dpi and lpi as well as other jetting parameters (see ESI†). We found that the filling conditions are quite resilient, allowing ink volumes from 3–4.5 μL per cell, which can be achieved by a two pass or three pass process (Table S3, ESI†). Following infiltration and drying, the devices were post-treated in damp heat for 100 h. This treatment increases the crystallinity of the perovskite layer as was determined by X-ray diffraction (ESI† Fig. S5). After optimizing the drying process following infiltration, high PCEs exceeding 13% for a device area of 1.5 cm² with 0.64 cm² aperture (Table 1 and Table S3, ESI†).

| Table 1 | Summary of photovoltaic parameters of inkjet printing development by replacing one screen printed layer by one inkjet printed layer of the reference screen printed MPSC stack. All parameters are given for reverse scan only. The median values with standard deviation as well as the champion cell figures (*) are indicated |
|-----------------|-----------------|-----------------|-----------------|-----------------|
| Inkjet printed layer | Print pass | $V_{oc}$ (V) | $J_{sc}$ (mA cm⁻²) | FF (%) | PCE (%) |
| Reference device | 1× | 0.92 | 23.7 | 66.1 | 12.9 |
| c-TiO₂ | 2× | 0.87 ± 0.04 (0.87*) | 19.1 ± 3.0 (22*) | 57.7 ± 1.2 (57.7*) | 9.9 ± 1.8 (11.1*) |
| m-TiO₂ | 2× | 0.87 ± 0.01 (0.86*) | 13.5 ± 3.6 (12.9*) | 68.2 ± 1.1 (77.6*) | 8.5 ± 1.8 (8.7*) |
| c-TiO₂ and m-TiO₂ | As above | 0.86* | 17.8* | 65.6* | 10.2* |
| m-ZrO₂ | 3× | 0.9 ± 0.03 (0.9*) | 18.7 ± 0.8 (19.1*) | 70.1 ± 1.5 (71.8*) | 11.9 ± 0.7 (12.4*) |
| MAPbI₃ | 1×, 2× | 0.96 ± 0.01 (0.96*) | 20.2 ± 0.3 (20.8*) | 67.4 ± 0.7 (67*) | 12.9 ± 1.0 (13.5*) |
| c-TiO₂, m-TiO₂, m-ZrO₂ and MAPbI₃ | As above | 0.92 ± 0.02 (0.9*) | 14.4 ± 1.6 (17.2*) | 68.5 ± 4.7 (59*) | 8.7 ± 0.8 (9.1*) |

Fig. 2 | Wetting envelopes of the various surfaces of the MPSC stack, which are relevant for the deposition of printable inks. Surface energies of the various solvents used to develop printable inks lie inside the wetting envelope of the different oxides and fluorine doped tin oxide (FTO) and therefore predict good wetting behavior (a). Conventional infiltration of MAPI precursor solution by semi-automatic pipetting method (b) and by inkjet infiltration (c) showing under-filling (left), ideal filling (middle) and overfilling (right, marked in red).
could be achieved on the sprayed and screen printed reference stack. This is significantly higher than the previously reported PCE of 8.5% using a four times smaller aperture area.26 Interestingly, partial MAPI infiltration allowed to assess the crucial importance of the thick mesoporous layers on absorber stability. At low filling volumes, the cells turned yellow after three months of exposure to ambient atmosphere, revealing the transformation of the perovskite into PbI₂. But fully infiltrated stacks remained black, hinting at the formation of a passivation layer protecting the active perovskite material underneath (ESI† Fig. S6a).

Inkjet printing for all the oxides as well as the perovskite ink was carried out at a speed of 200 mm s⁻¹ with multi swath and multipass printing as stated in Table 1. Using such printing speed allows to print the 18-cell design shown in Fig. S1 of the ESI† with two passes in about 4 minutes.

Device fabrication and characterization

Optimized MPSC today reach efficiencies of 15–17%36 on the lab scale. To bring this technology to an industrial level, however, reproducible large area fabrication has to be developed. Besides the recurrent issue of defects and pinholes coming along with increasing the active area, problems associated with large area are the homogeneity of the layers in terms of thickness and crystallinity. Of particular interest are cell areas of the order of 1 cm², since they are relevant to the length scale used in series connection geometries applied in modules. There are several encouraging reports where cell areas of 1 cm² or more with efficiencies of 12–19% have been achieved.37 Large area modules of more than 10 to 100 cm² have also been reported with active area efficiencies ranging from 5–15%.38,39 As pointed out in the perspective article by Rong et al., the most appropriate technique for large area fabrication is slot die coating.40 However, this technique is less well suited for customizing the shape of the active area. Our goal was to reach customizable cells on large area using digital inkjet printing. Albeit the challenges brought about by inkjet printing thick nanoparticle layers, we chose the MPSC architecture, because it is more resilient towards pinholes and allows convenient infiltration of the perovskite absorber ink. To date MPSC also reveal the longest lifetime of more than 1 year.31

The printing parameters were first optimized for the individual oxide layers on glass substrates. Large area film homogeneity was assessed by visual inspection, both in the wet and dry state. For the scattering mesoporous oxide layers, the degree of opaqueness can easily be detected by eye as shown in Fig. S1(c) and (d) (ESI†). For the ultrathin c-TiO₂ layer, visual inspection is carried out at a certain tilt angle, where interference fringes can be observed. On a smaller scale of 3.5 × 3.5 μm, we performed atomic force microscopy (AFM) scans (ESI† Fig. S3). We extracted line scans in order to visualize the surface roughness of the oxide films (ESI† Fig. S4). Typical roughness values of 10 nm and 15 nm, were obtained for m-TiO₂ and m-ZrO₂, respectively, showing smooth and continuous films with respect to the nano-particulate nature of the inks and the layer thicknesses. Ultrathin c-TiO₂ films, however, present dewetting features.

In order to evaluate the quality of the screen-printed layers, we proceeded stepwise and used the screen printed cell as a reference. Each layer of the device stack (except carbon) was then replaced by an inkjet printed layer to verify its functionality within the stack. Note that if not otherwise indicated, the perovskite ink infiltration was carried out by pipetting 5.7 μL of perovskite ink per cell area of 1.5 cm². There are several conclusions that can be drawn from this study. As can be inferred from Table 1, the infiltration of MAPI using inkjet performs as well as the pipetting method. This is a very encouraging result, since inkjet infiltration can potentially be used to screen different perovskite precursor inks and to study additives in a convenient systematic way. Replacing the screen printed titania layers by inkjet printed layers did however affect the power conversion efficiency (PCE) to some extent. This may be due to the reduced thickness obtained for m-TiO₂ using inkjet. While the layer thicknesses were optimized on glass to achieve a thickness of 500 nm after firing, the thickness of m-TiO₂ obtained in the device as measured by SEM is around 350–400 nm (see Fig. 3). The lower thickness obtained in the MPSC stack may be due to the different wetting behavior of glass and c-TiO₂. Additionally the FTO roughness adds to the thickness variation of m-TiO₂ in the device. This means that the absorber layer is thinner than in the reference device and consequently, the photoinduced charge carrier generation decreases. The fact that the short circuit current density was most affected by inkjet printing m-TiO₂ underlines this reasoning.

Inkjet printing the c-TiO₂ layer mainly affects the fill factor of the device. The reason could be related to the difficulty to obtain such an ultrathin continuous layer on a rough FTO substrate. AFM images indeed confirm thickness inhomogeneities of the inkjet printed c-TiO₂ layer (ESI† Fig. S3a). It is likely that spray pyrolysis employed in the reference device is superior to inkjet printing in terms of thickness uniformity. In order to evaluate the quality of the inkjet printed layers, we proceeded stepwise and used the screen printed cell as a reference. Each layer of the device stack (except carbon) was then replaced by an inkjet printed layer to verify its functionality within the stack. Note that if not otherwise indicated, the perovskite ink infiltration was carried out by pipetting 5.7 μL of perovskite ink per cell area of 1.5 cm². There are several conclusions that can be drawn from this study. As can be inferred from Table 1, the infiltration of MAPI using inkjet performs as well as the pipetting method. This is a very encouraging result, since inkjet infiltration can potentially be used to screen different perovskite precursor inks and to study additives in a convenient systematic way. Replacing the screen printed titania layers by inkjet printed layers did however affect the power conversion efficiency (PCE) to some extent. This may be due to the reduced thickness obtained for m-TiO₂ using inkjet. While the layer thicknesses were optimized on glass to achieve a thickness of 500 nm after firing, the thickness of m-TiO₂ obtained in the device as measured by SEM is around 350–400 nm (see Fig. 3). The lower thickness obtained in the MPSC stack may be due to the different wetting behavior of glass and c-TiO₂. Additionally the FTO roughness adds to the thickness variation of m-TiO₂ in the device. This means that the absorber layer is thinner than in the reference device and consequently, the photoinduced charge carrier generation decreases. The fact that the short circuit current density was most affected by inkjet printing m-TiO₂ underlines this reasoning.

Fig. 3  SEM images of inkjet printed MPSC cell cross sections showing the three oxide layers, fluorine doped tin oxide (FTO) as well as the thick carbon electrode (a). For clarity, the zoom-in picture is colored and shows the cross-section of a non-infiltrated stacks (b) and a stack infiltrated with perovskite (c).
in this respect. Inkjet printing the m-ZrO₂ layer gave very similar results as for the reference device. The latter layer acts merely as a space holder to avoid direct contact between the carbon electrode and m-TiO₂ and therefore its effect is less sensitive.

Eventually, we achieved a large area (full area of 1.5 cm²) solar cell with a PCE of 9.1% measured with an aperture of 0.64 cm², where all oxide layers and the perovskite absorber were deposited by inkjet (Fig. 4). The current–voltage (J–V) characteristics show rather small hysteresis, even though some efficiency loss is observed as compared to the screen printed reference device. As discussed, the lower short circuit current density J_{sc} hints towards a reduced active layer thickness as compared to the reference device. Very likely, the lower fill factor may be related to the difficulty of inkjet printing an ultrathin pinhole-free c-TiO₂ layer. At this stage, the fully inkjet printed solar cell bears a lot of optimization potential. A thorough investigation of the device physics is still missing and has to be carried out in forthcoming work.

We undertook first attempts to also inkjet print the top electrode using ITO and carbon inks (see ESI† Table S4). This preliminary attempts yielded rather poor efficiencies below 1%. Further developments in this direction will be addressed in future work.

Conclusions

In this work, we achieved inkjet printed carbon based solar cells with four layers out of five being inkjet deposited using environment friendly non-halogenated solvents. This includes all oxide layers, i.e. c-TiO₂, m-TiO₂, m-ZrO₂ as well as the perovskite precursor ink. We have demonstrated extensive ink development of nanoparticles for stable jetting and wetting as well as MPSC device performance. We demonstrated large area solar cell devices with an efficiency of 9.1%. If the organo-metal iodide (MAPI) ink was infiltrated into reference monolithic stacks produced by screen printing, we achieved a power conversion efficiency of 13.5%, which is a breakthrough for a device area larger than 1 cm². Given the fact that inkjet technology is scalable, there are high prospects for printing larger device areas. Furthermore, inkjet printing enables customized complex cell geometries for specific applications, such as personal wearable or small utility power sources as well as building integrated photovoltaics. Inkjet printing of carbon and metal oxides for electrodes remain a challenge and requires further ink and process development.

Conflicts of interest

There are no conflicts of interest to declare.

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